Enhanced Optical Polarization of Nitride LEDs by Increased Indium Incorporation
Tech ID: 23654 / UC Case 2008-323-0

BRIEF DESCRIPTION
A novel technique of improving performance in nonpolar LEDs by obtain high polarization ratios.

BACKGROUND
In recent years, III-V nitride-based blue and green LEDs have begun to emerge in general lighting and full color display applications. Internal electrical polarization is a unique property of the (Al,In,Ga)N system. Since atoms in the III-V nitride system do not maintain their ideal positions, this polarization field almost always exists along the c-axis, making the c-plane a polar plane. In contrast, III-V nitride-based LEDs conventionally grown on the c-plane show negligible light polarization.

DESCRIPTION
Researchers at the University of California, Santa Barbara have developed a novel technique to obtain high polarization ratios from nonpolar LEDs, thereby improving performance. The present invention accomplishes higher polarization ratios in electroluminescence from nonpolar LEDs by increasing the indium content in light-emitting layers. A possible modification of this invention is to introduce strain controlling layers in the LED structure, which results in increased polarization ratios. The present invention requires no extra process in material growths, clean room processing, or device packaging.

ADVANTAGES
- Higher polarization ratios in nonpolar LEDs
- No additional manufacturing steps necessary
- Size and energy efficient backlighting

APPLICATIONS
- Backlighting for liquid crystal displays (LCDs)
- Other lighting applications

PATENT STATUS
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INVENTORS
- DenBaars, Steven P.
- Iso, Kenji
- Masui, Hisashi
- Nakamura, Shuji
- Speck, James S.
- Yamada, Hisashi

OTHER INFORMATION
KEYWORDS
indssl, indled, LEDs

CATEGORIZED AS
- Engineering
- Energy
  - Lighting
- Other
- Semiconductors
  - Design and Fabrication

RELATED CASES
2008-323-0

ADDITIONAL TECHNOLOGIES BY THESE INVENTORS
- Method for Improved Surface of (Ga,Al,In,B)N Films on Nonpolar or Semipolar Subtrates
- High Efficiency LED with Optimized Photonic Crystal Extractor
- Etching Technique for the Fabrication of Thin (Al, In, Ga)N Layers
Lateral Growth Method for Defect Reduction of Semipolar Nitride Films
Vertical Cavity Surface-Emitting Lasers with Continuous Wave Operation
Low-Cost Zinc Oxide for High-Power-Output, GaN-Based LEDs (UC Case 2010-183)
Defect Reduction in GaN films using in-situ SiNx Nanomask
Enhanced Light Extraction LED with a Tunnel Junction Contact Wafer Bonded to a Conductive Oxide
Highly Efficient Blue-Violet III-Nitride Semipolar Laser Diodes
Hybrid Growth Method for Improved III-Nitride Tunnel Junction Devices
Volumetric Hole Injection with Intentional V-Defects
Low Temperature Deposition of Magnesium Doped Nitride Films
Transparent Mirrorless (TML) LEDs
Improved GaN Substrates Prepared with Ammonothermal Growth
Optimization of Laser Bar Orientation for Nonpolar Laser Diodes
High Efficiency Semipolar AlGaN-Cladding-Free Laser Diodes
Method for Growing Self-Assembled Quantum Dot Lattices
Size-Independent Forward Voltage Micro-LED with an Epitaxial Junction
Method for Enhancing Growth of Semipolar Nitride Devices
III-Nitride Tunnel Junction with Modified Interface
Growth of Polyhedron-Shaped Gallium Nitride Bulk Crystals
Nonpolar III-Nitride LEDs With Long Wavelength Emission
Improved Fabrication of Nonpolar InGaN Thin Films, Heterostructures, and Devices
Growth of High-Quality, Thick, Non-Polar M-Plane GaN Films
Increased Light Extraction with Multistep Deposition of ZnO on GaN
Method for Manufacturing Improved III-Nitride LEDs and Laser Diodes: Monolithic Integration of Optically Pumped and Electrically Injected III-Nitride LEDs
Selective-Area Mesoporous Semiconductors And Devices For Optoelectronic And Photonic Applications
High-Efficiency, Mirrorless Non-Polar and Semi-Polar Light Emitting Devices
Method for Growing High-Quality Group III-Nitride Crystals
Controlled Photoelectrochemical (PEC) Etching by Modification of Local Electrochemical Potential of Semiconductor Structure
Incorporating Temperature-Sensitive Layers in III-N Devices
Oxyfluoride Phosphors for Use in White Light LEDs
Technique for the Nitride Growth of Semipolar Thin Films, Heterostructures, and Semiconductor Devices
(In,Ga,Al)N Optoelectronic Devices with Thicker Active Layers for Improved Performance
MOCVD Growth of Planar Non-Polar M-Plane Gallium Nitride
Reduced Dislocation Density of Non-Polar GaN Grown by Hydride Vapor Phase Epitaxy
Heterogeneously Integrated GaN on Si Photonic Integrated Circuits
Reduction in Leakage Current and Increase in Efficiency of III-Nitride MicroLEDs
Methods for Fabricating III-Nitride Tunnel Junction Devices
Low-Droop LED Structure on GaN Semi-polar Substrates
Contact Architectures for Tunnel Junction Devices
Semi-polar LED/LD Devices on Relaxed Template with Misfit Dislocation at Hetero-interface
Photoelectrochemical Etching Of P-Type Semiconductor Heterostructures
Semipolar-Based Yellow, Green, Blue LEDs with Improved Performance
Growth of Semipolar III-V Nitride Films with Lower Defect Density
III-Nitride Tunnel Junction LED with High Wall Plug Efficiency
Improved Manufacturing of Solid State Lasers via Patternning of Photonic Crystals
Solid Solution Phosphors for Use in Solid State White Lighting Applications
Multifaceted III-Nitride Surface-Emitting Laser
Tunable White Light Based on Polarization-Sensitive LEDs
Cleaved Facet Edge-Emitting Laser Diodes Grown on Semipolar GaN
Growth of High-Performance M-plane GaN Optical Devices
Packaging Technique for the Fabrication of Polarized Light Emitting Diodes
Improved Anisotropic Strain Control in Semipolar Nitride Devices
High Light Extraction Efficiency III-Nitride LED
III-V Nitride Device Structures on Patterned Substrates
Activation of P-Type Layers of Tunnel Junctions in Micro-LEDs
Method for Increasing GaN Substrate Area in Nitride Devices
Nitride Based Ultraviolet LED with an Ultraviolet Transparent Contact
Growth of Planar, Non-Polar, A-Plane GaN by Hydride Vapor Phase Epitaxy
Single or Multi-Color High Efficiency LED by Growth Over a Patterned Substrate

GaN-Based Thermoelectric Device for Micro-Power Generation

Limiting Strain-Relaxation in III-Nitride Heterostructures by Substrate Patterning

Improved Manufacturing of Semiconductor Lasers

LED Device Structures with Minimized Light Re-Absorption

Growth of Planar Semi-Polar Gallium Nitride

Nonpolar (Al, B, In, Ga)N Quantum Well Design

UV Optoelectronic Devices Based on Nonpolar and Semi-polar AlInN and AlInGaN Alloys

Integration And Mass Transfer Of Microleds

Defect Reduction of Non-Polar and Semi-Polar III-Nitrides

II-Nitride Based VCSEL with Curved Mirror on P-Side of the Aperture

Low-Cost Zinc Oxide for High-Power-Output, GaN-Based LEDs (UC Case 2010-150)

Suppression of Defect Formation and Increase in Critical Thickness by Silicon Doping

Wafer Bonding for Embedding Active Regions with Relaxed Nanofeatures

Enhancing Growth of Semipolar (Al,In,Ga,B)N Films via MOCVD